

MOSFET

OptiMOS[™] 5 Power-Transistor, 80 V

Features

- Optimized for high performance SMPS, e.g. synchronous rectification N-channel, logic level Very low on-resistance $R_{DS(on)}$ Superior thermal resistance

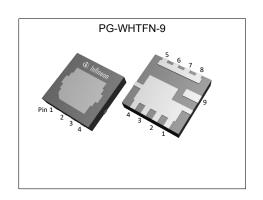
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

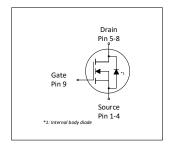
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	80	V
R _{DS(on),max} @10V	4.6	mΩ
R _{DS(on),max} @4.5V	5.9	mΩ
I_{D}	99	A
Q _{oss}	39	nC
Q _G (0V4.5V)	19	nC











Type / Ordering Code	Package	Marking	Related Links
IQE046N08LM5CGSC	PG-WHTFN-9	R	-

OptiMOS[™] 5 Power-Transistor, 80 V IQE046N08LM5CGSC





Table of Contents

escription	1
1aximum ratings	3
hermal characteristics	3
lectrical characteristics	4
lectrical characteristics diagrams	6
ackage Outlines	0
evision History	1
rademarks 1	1
nisclaimer	1

OptiMOS[™] 5 Power-Transistor, 80 V IQE046N08LM5CGSC



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	O b. a.l	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	99 70 62 15.6	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =60°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	396	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	170	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	100 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Faranietei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.9	1.5	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	0.7	-	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 80 V IQE046N08LM5CGSC



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.1	1.7	2.3	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =47 μ A
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	4.0 5.2	4.6 5.9	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =10 A
Gate resistance	R _G	-	0.6	0.9	Ω	-
Transconductance ¹⁾	g fs	-	62	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 \text{ A}$

Table 5 **Dynamic characteristics**

Parameter	Cymahal	Values			11	Nata / Tank Candikian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	2500	3250	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	390	507	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	26	47	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	5.2	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	2.6	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	18	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	4.4	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Comple at	Values			11:4	Nata / Tast Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	7	-	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	4.3	-	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	6.4	9.6	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q _{sw}	-	9.1	-	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate charge total ¹⁾	Q g	-	19	24	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.8	-	V	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate charge total	Q g	-	38	-	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	39	51	nC	V _{DS} =40 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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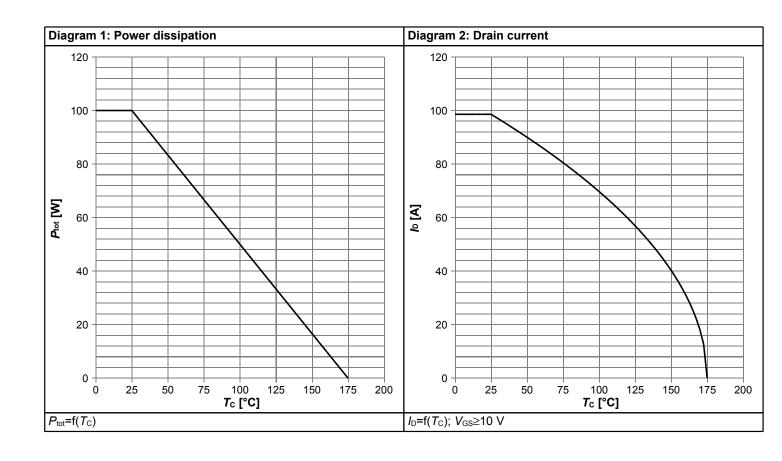


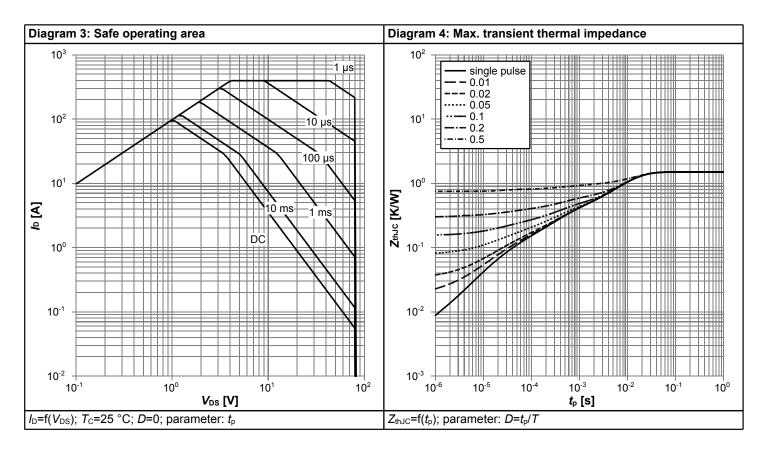
Table 7 Reverse diode

Parameter	Cymphol		Values			Nata / Tank Canadition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	83	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	396	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.83	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	32	64	ns	V _R =40 V, I _F =20 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	26	52	nC	V _R =40 V, I _F =20 A, di _F /dt=100 A/μs
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	18	36	ns	V _R =40 V, I _F =20 A, di _F /dt=1000 A/μs
Reverse recovery charge ¹⁾	Qrr	-	129	258	nC	V _R =40 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =1000 A/μs

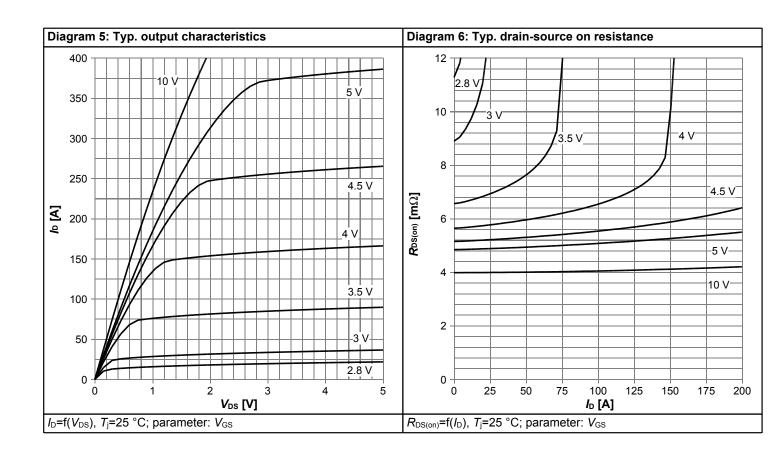


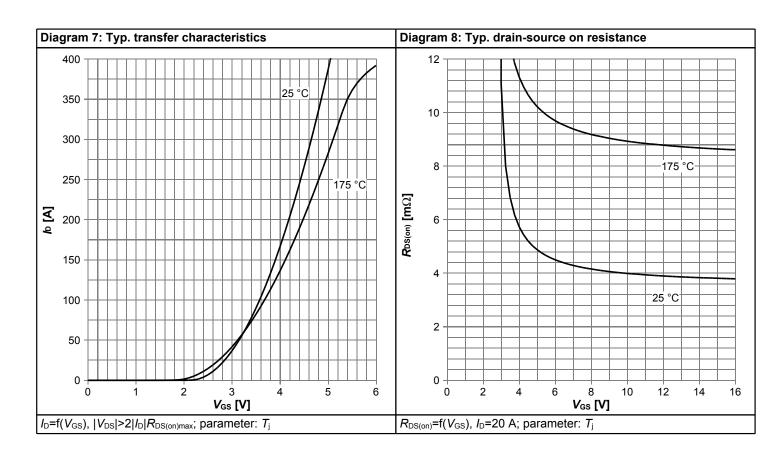
4 Electrical characteristics diagrams



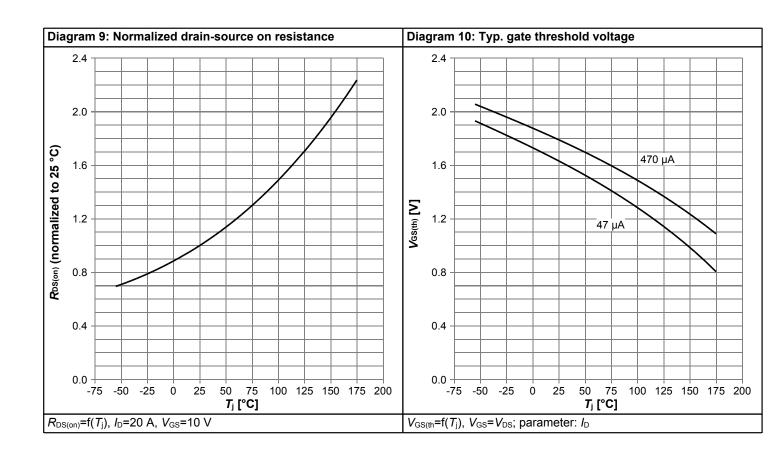


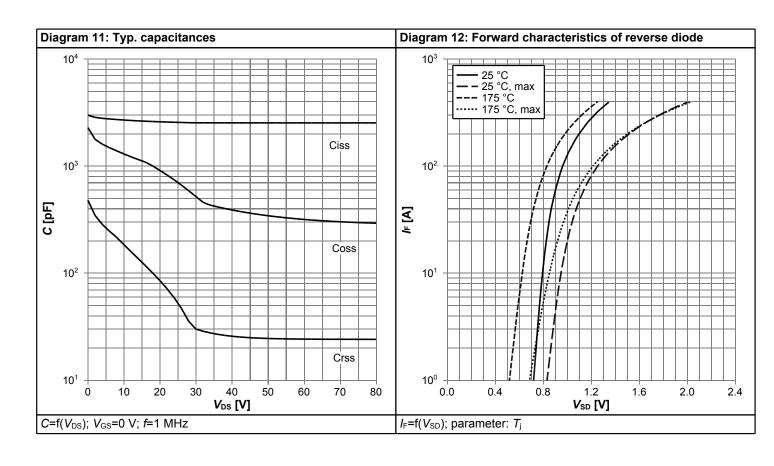




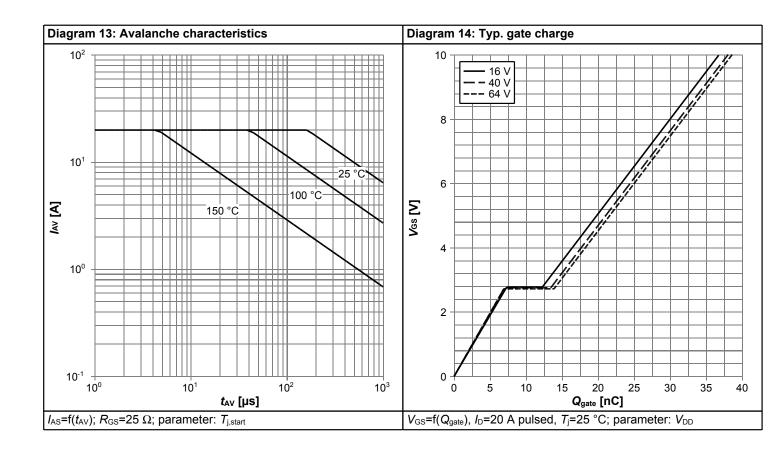


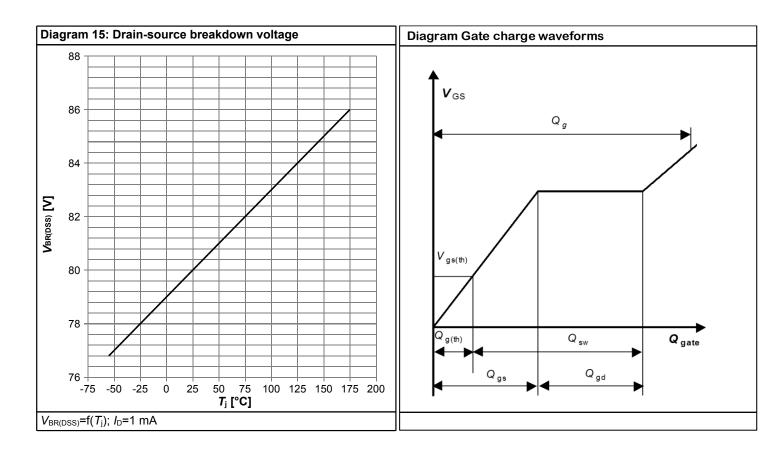














5 Package Outlines

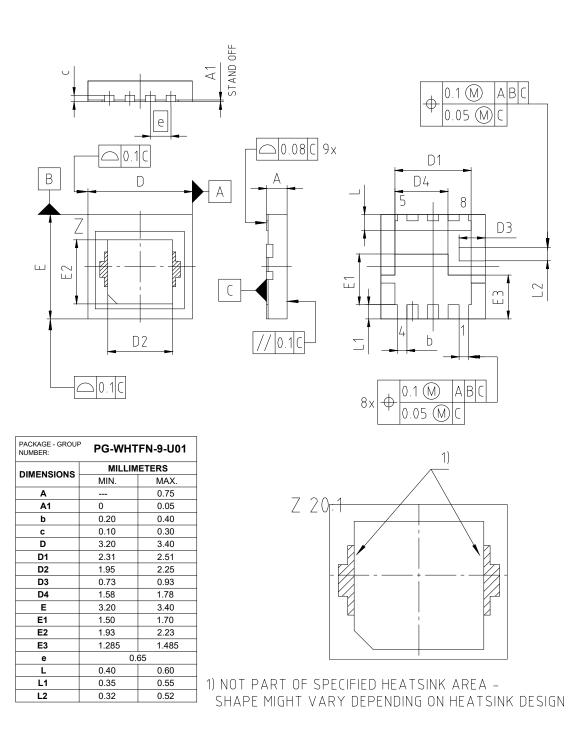


Figure 1 Outline PG-WHTFN-9, dimensions in mm

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Revision History

IQE046N08LM5CGSC

Revision: 2023-01-12, Rev. 2.0

D	D
Previous	Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2023-01-12	Release of final version

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Final Data Sheet 11 Rev. 2.0, 2023-01-12